FAIRCHILD SEMICONDUCTOR®

November2009

Ultra FRFET™

FDP5N50U / FDPF5N50UT

N-Channel MOSFET, FRFET

500V, 4A, 2.0Ω

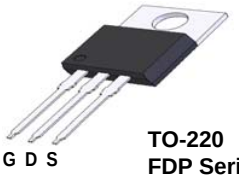
Features

- $R_{DS(on)}$ = 1.65Ω (Typ.)@ V_{GS} = 10V, I_D = 2A
- Low gate charge (Typ. 11nC)
- Low C_{rss} (Typ. 5pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability
- RoHS compliant

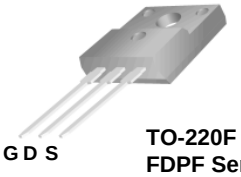
Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DOMS technology.

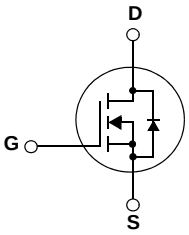
This advance technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutationmode. These devices are well suited for high efficient switched mode power supplies and active power factor correction.



TO-220
FDP Series



TO-220F
FDPF Series
(potted)



MOSFET Maximum Ratings T_C = 25°C unless otherwise noted*

Symbol	Parameter		FDP5N50U	FDPF5N50UT	Units
V_{DSS}	Drain to Source Voltage		500		V
V_{GSS}	Gate to Source Voltage		±30		V
I_D	Drain Current	-Continuous (T_C = 25°C)	4	4*	A
		-Continuous (T_C = 100°C)	2.4	2.4*	
I_{DM}	Drain Current	- Pulsed (Note 1)	16	16*	A
E_{AS}	Single Pulsed Avalanche Energy	(Note 2)	216		mJ
I_{AR}	Avalanche Current	(Note 1)	4		A
E_{AR}	Repetitive Avalanche Energy	(Note 1)	8.5		mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.5		V/ns
P_D	Power Dissipation	(T_C = 25°C)	85	28	W
		- Derate above 25°C	0.67	0.22	W/°C
T_J, T_{STG}	Operating and Storage Temperature Range		-55 to +150		°C
T_L	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds		300		°C

*Drain current limited by maximum junction temperature

Thermal Characteristics

Symbol	Parameter	FDP5N50U	FDPF5N50UT	Units
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.4	4.5	°C/W
$R_{\theta CS}$	Thermal Resistance, Case to Sink Typ.	0.5	-	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	62.5	62.5	

Package Marking and Ordering Information $T_C = 25^oC$ unless otherwise noted

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDP5N50U	FDP5N50U	TO-220	-	-	50
FDPF5N50UT	FDPF5N50UT	TO-220F	-	-	50

Electrical Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
Off Characteristics						
BV_{DSS}	Drain to Source Breakdown Voltage	I_D = 250μA, V_{GS} = 0V, T_J = 25°C	500	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I_D = 250μA, Referenced to 25°C	-	0.7	-	V/°C
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 500V, V_{GS} = 0V	-	-	25	μA
		V_{DS} = 400V, T_C = 125°C	-	-	250	
I_{GSS}	Gate to Body Leakage Current	V_{GS} = ±30V, V_{DS} = 0V	-	-	±100	nA
On Characteristics						
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS} = V_{DS}, I_D = 250μA	3	-	5	V
$R_{DS(on)}$	Static Drain to Source On Resistance	V_{GS} = 10V, I_D = 2A	-	1.65	2	Ω
g_{FS}	Forward Transconductance	V_{DS} = 40V, I_D = 2A (Note 4)	-	4.8	-	S
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{DS} = 25V, V_{GS} = 0V, f = 1MHz	-	485	650	pF
C_{oss}	Output Capacitance		-	65	90	pF
C_{rss}	Reverse Transfer Capacitance		-	5	8	pF
$Q_{g(tot)}$	Total Gate Charge at 10V	V_{DS} = 400V, I_D = 4A, V_{GS} = 10V (Note 4, 5)	-	11	15	nC
Q_{gs}	Gate to Source Gate Charge		-	3	-	nC
Q_{gd}	Gate to Drain “Miller” Charge		-	5	-	nC
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time	V_{DD} = 250V, I_D = 4A, R_G = 25Ω (Note 4, 5)	-	14	38	ns
t_r	Turn-On Rise Time		-	21	52	ns
$t_{d(off)}$	Turn-Off Delay Time		-	27	64	ns
t_f	Turn-Off Fall Time		-	20	50	ns
Drain-Source Diode Characteristics						
I_S	Maximum Continuous Drain to Source Diode Forward Current		-	-	4	A
I_{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	16	A
V_{SD}	Drain to Source Diode Forward Voltage	V_{GS} = 0V, I_{SD} = 4A	-	-	1.6	V
t_{rr}	Reverse Recovery Time	V_{GS} = 0V, I_{SD} = 4A, dI_F/dt = 100A/μs (Note 4)	-	36	-	ns
Q_{rr}	Reverse Recovery Charge		-	33	-	nC

Notes:
1: Repetitive Rating: Pulse width limited by maximum junction temperature
2: L = 27mH, I_{AS} = 4A, V_{DD} = 50V, R_G = 25Ω, Starting T_J = 25°C
3: I_{SD} ≤ 4A, di/dt ≤ 200A/μs, V_{DD} ≤ BV_{DSS}, Starting T_J = 25°C
4: Pulse Test: Pulse width ≤ 300μs, Duty Cycle ≤ 2%
5: Essentially Independent of Operating Temperature Typical Characteristics

Typical Performance Characteristics

Figure 1. On-Region Characteristics

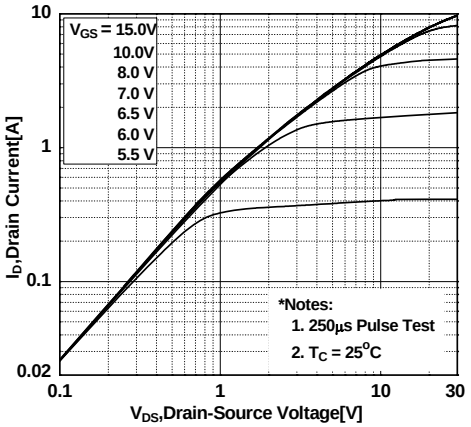


Figure 2. Transfer Characteristics

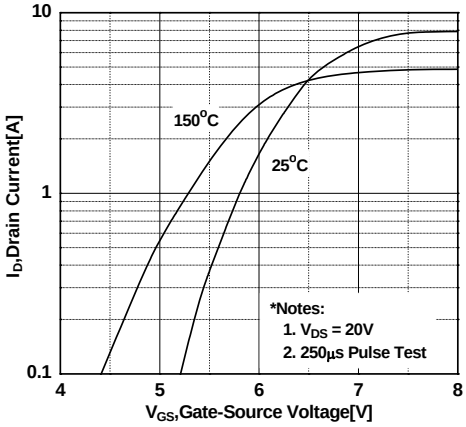


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

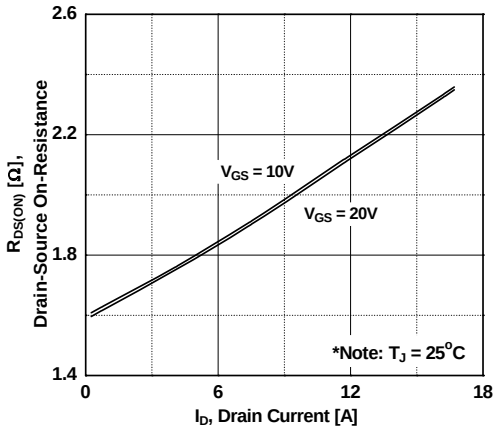


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

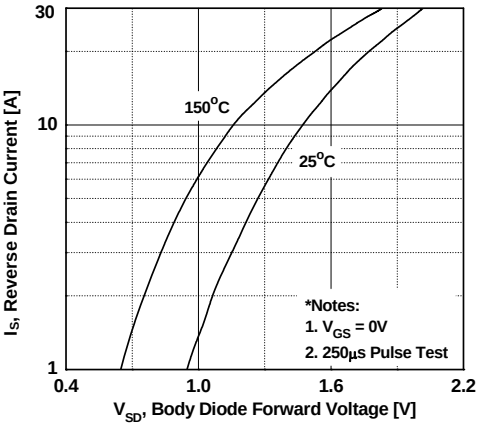


Figure 5. Capacitance Characteristics

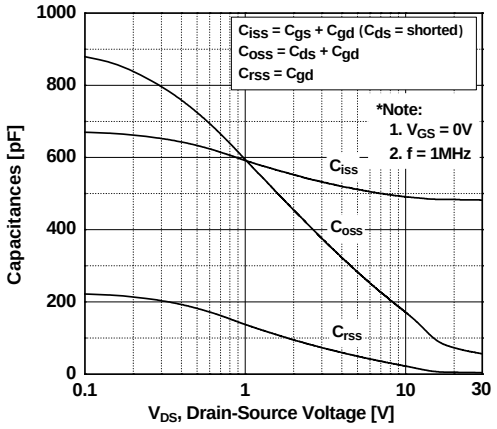
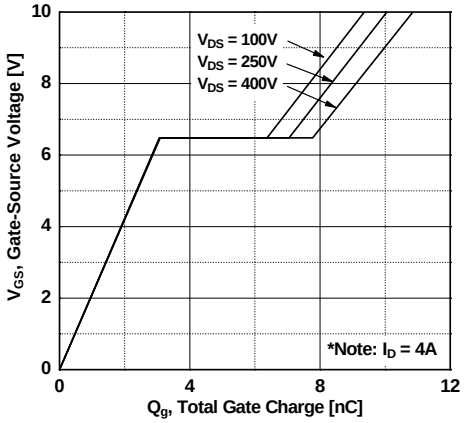


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

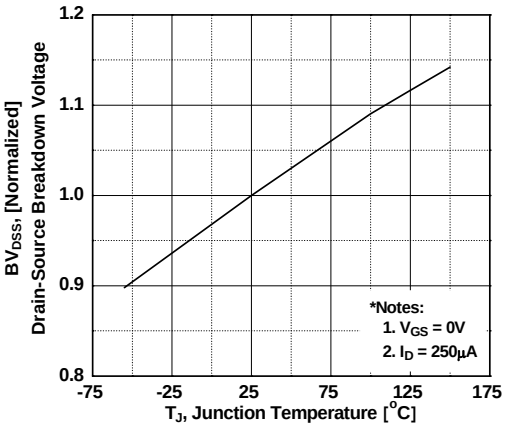


Figure 8. Maximum Safe Operating Area - FDP5N50U

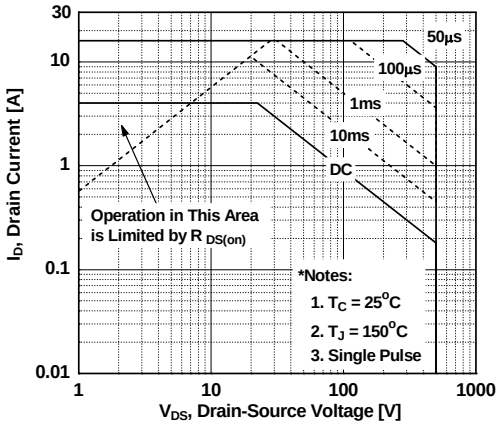


Figure 9. Maximum Safe Operating Area - FDPF5N50UT

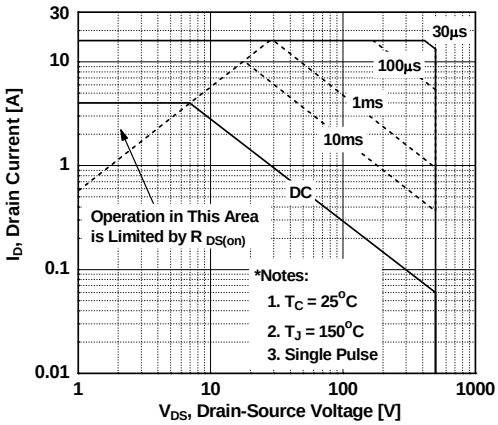


Figure 10. Maximum Drain Current vs. Case Temperature

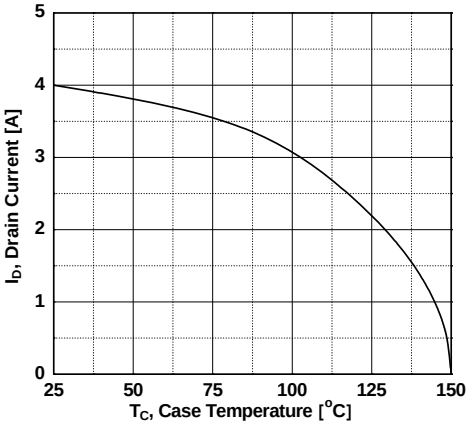
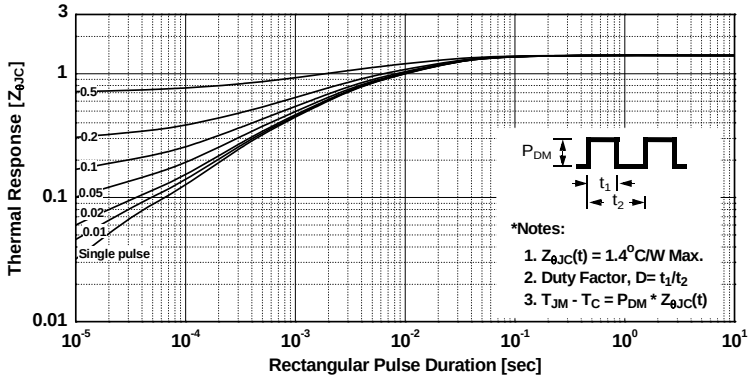
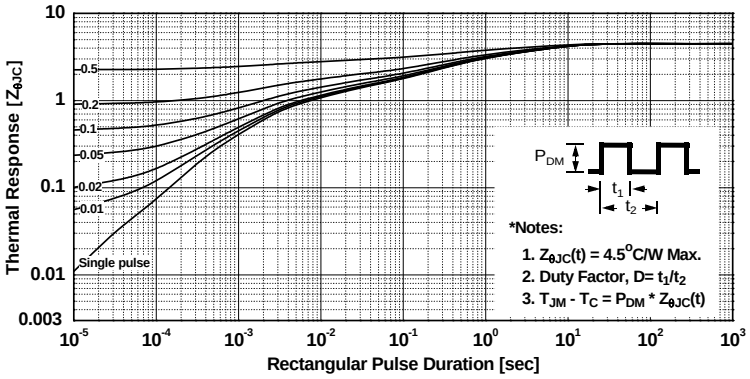


Figure 11. Transient Thermal Response Curve - FDP5N50U

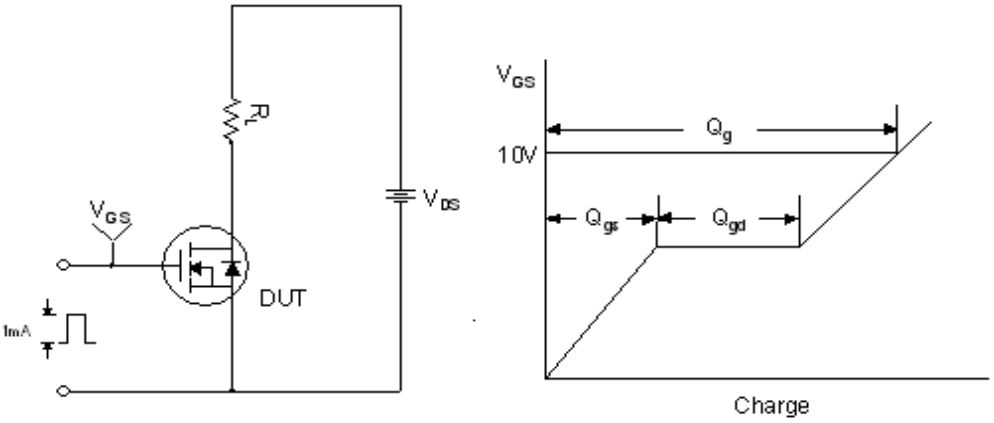


Typical Performance Characteristics (Continued)

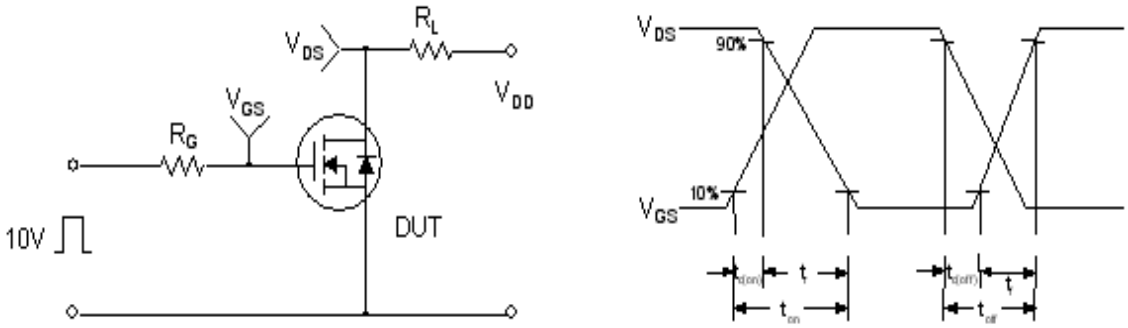
Figure 12. Transient Thermal Response Curve - FDPF5N50UT



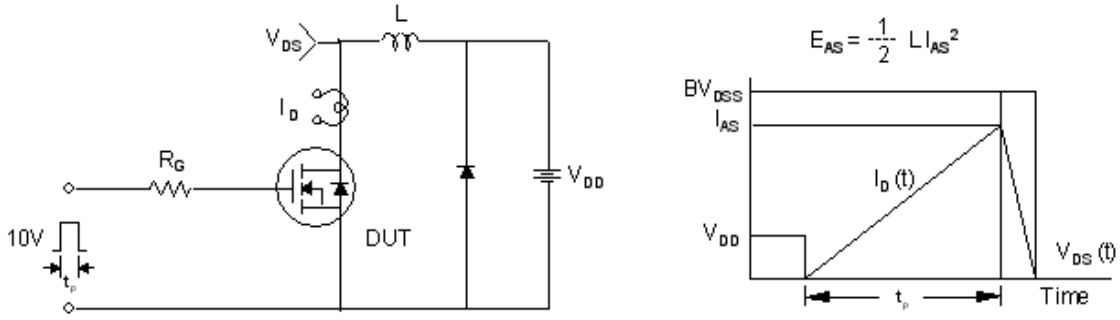
Gate Charge Test Circuit & Waveform



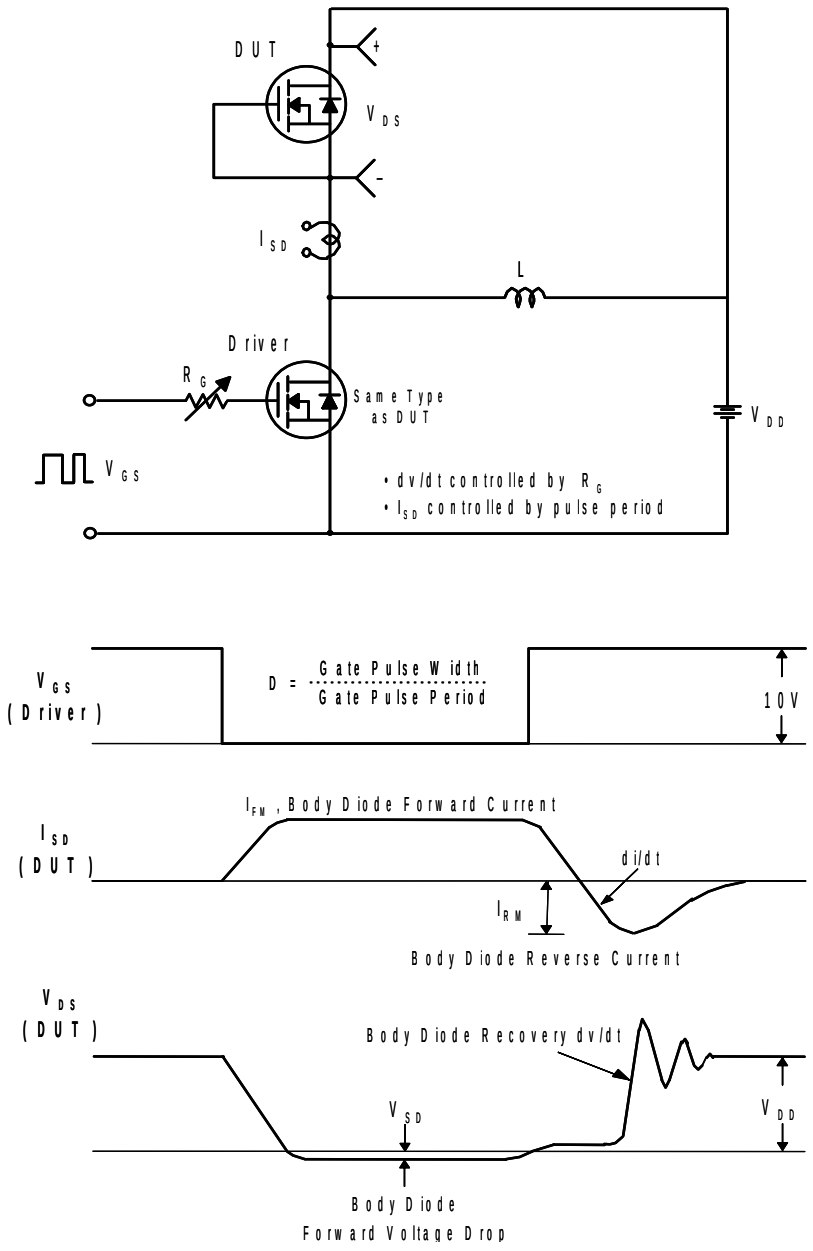
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms

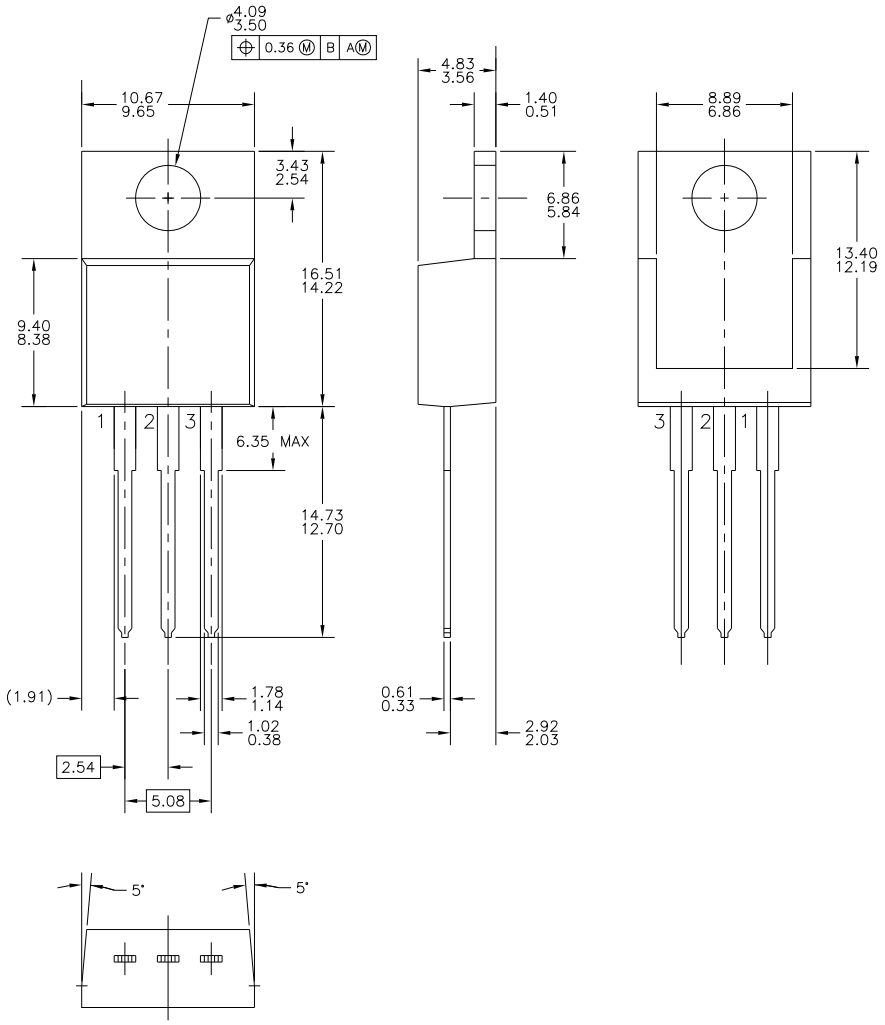


Peak Diode Recovery dv/dt Test Circuit & Waveforms



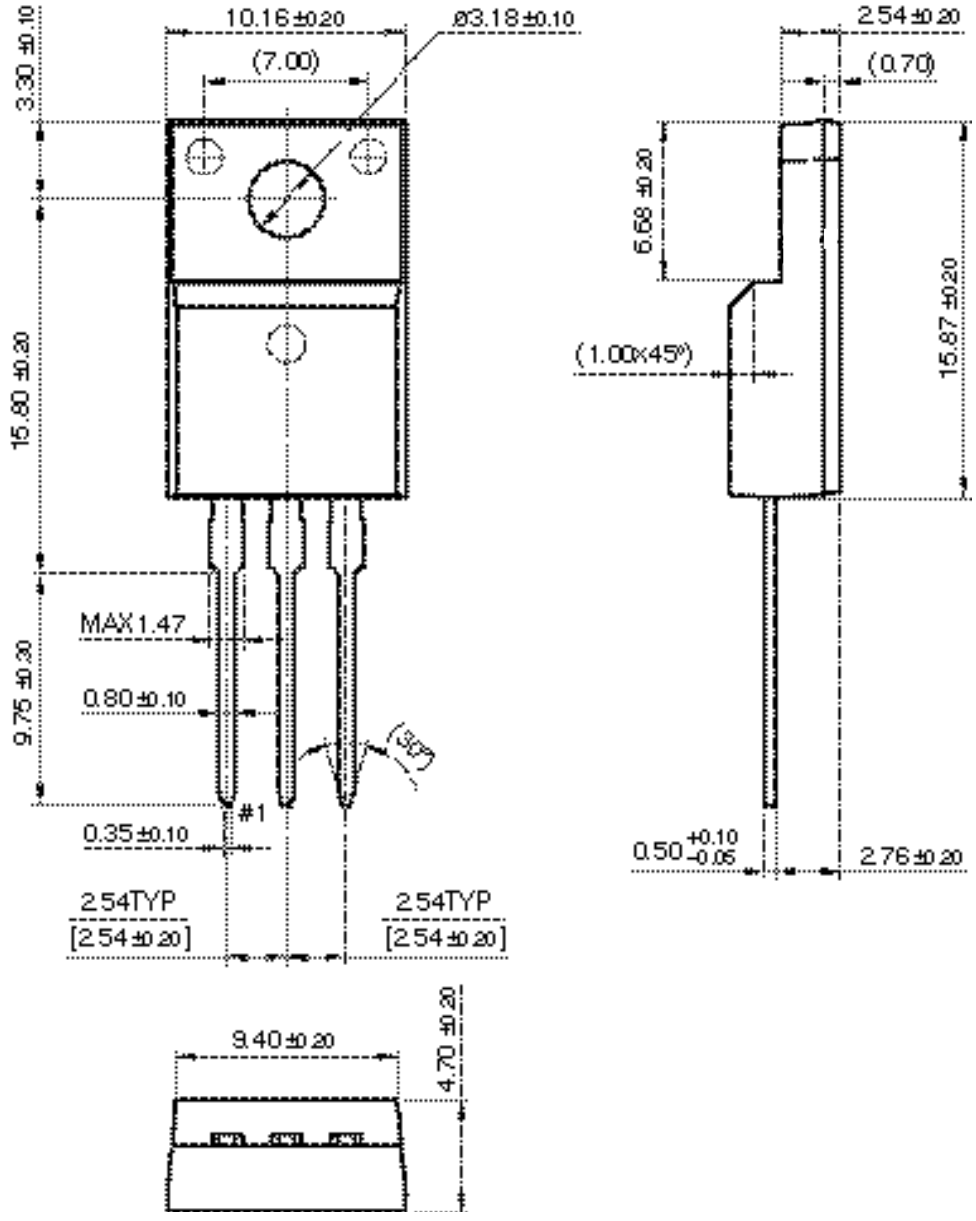
Mechanical Dimensions

TO-220



Package Dimensions (Continued)

TO-220F



* Front/Back Side Isolation Voltage : 2500V

Dimensions in Millimeters

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